

BEYOND SMART

JULY 10-12, 2018 | MOSCONE CENTER | SAN FRANCISCO, CA

Test Vision 2020 Sponsorship Packages

Partner, Sustainer, and Supporter

Test Vision is now in its eleventh year and is a two-time winner of the “Most Successful Event” Award of the IEEE Test Technology Technical Council. Last year’s event attracted over 100 attendees, who are the drivers of test strategy in their respective companies. This year’s theme is *The Next Step to Intelligent Test*, focusing on the new challenges of emerging technologies and the economics of developing smarter test programs using key learnings from test data.

As a sponsor, you can choose a Partner, Sustainer, or Supporter sponsorship package to promote your brand and increase your visibility at SEMICON West and Test Vision 2020 with attendees—before and during the event! Packages include company and logo placement on web pages, email, and other marketing assets.

	PARTNER \$2,000	SUSTAINER \$1,000	SUPPORTER \$500
Pre-event Branding and Onsite Recognition			
Company name featured on workshop gift	◆	◆	◆
Company logo featured on Test Vision website and SEMICON West Test Vision Programs and Sponsor web page	◆	◆	◆
Company logo featured on workshop promotional materials—with Partner and Sustainer levels receiving even more prominent placement	◆	◆	◆
Company logo featured on welcome slides and onsite signage	◆	◆	◆
Emcee sponsorship recognition	◆	◆	◆
Table top display at the conference	◆	◆	
Exclusive recognition as the Partner Sponsor at the workshop with most prominent placement on collateral and marketing material	◆		
Sponsorship recognition at luncheon or other social events	◆		

Test Vision 2020 Sponsorship Application Form

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Please bill my Visa MasterCard American Express

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TEST VISION 2020

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